

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5853764

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YING-CHIH CHEN	11/12/2019
YEN-JU LU	11/12/2019
CHE-YA CHOU	12/06/2019
HSING-CHIH LIU	11/14/2019
RECEIVING PARTY DATA	
Name:	MEDIATEK INC.
Street Address:	NO. 1, DUSING RD. 1ST, SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16699851
CORRESPONDENCE DATA	
Fax Number:	(404)521-4286
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	678-483-8899
Email:	dan.mcclure@mqlaw.com
Correspondent Name:	MCCLURE, QUALEY & RODACK, LLP
Address Line 1:	280 INTERSTATE NORTH CIRCLE SE
Address Line 2:	SUITE 550
Address Line 4:	ATLANTA, GEORGIA 30339
ATTORNEY DOCKET NUMBER:	251311-2180
NAME OF SUBMITTER:	DANIEL R. MCCLURE
SIGNATURE:	/Daniel R. McClure/
DATE SIGNED:	12/06/2019
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 5	

source=00742573#page1.tif

source=00742573#page2.tif

source=00742573#page3.tif

source=00742573#page4.tif

source=00742573#page5.tif

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Ying-Chih CHEN, Yen-Ju LU, Che-Ya CHOU and Hsing-Chih LIU

, hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to

SEMICONDUCTOR PACKAGE

☒ said application being attached hereto;

☐ said application having been filed in the United States Patent and Trademark Office on _____, as Application Serial No. _____, and was amended on _____ (if applicable);

☐ the specification of which was filed under the Patent Cooperation Treaty on _____,

Serial No. _____, the United States of America being designated.

AND WHEREAS MEDIATEK Inc., hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature Ying-Chih Chen
Legal Name: Ying-Chih CHEN
Date: 11/12/2018

ASSIGNOR (SECOND INVENTOR):

Signature: _____
Legal Name: Yen-Ju LU
Date: _____

ASSIGNOR (THIRD INVENTOR):

Signature: _____
Legal Name: Che-Ya CHOU
Date: _____

ASSIGNOR (FOURTH INVENTOR):

Signature: _____
Legal Name: Hsing-Chih LIU
Date: _____

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature: _____

Legal Name: Ying-Chih CHEN

Date: _____

ASSIGNOR (SECOND INVENTOR):

Signature: Yen-Ju Lu

Legal Name: Yen-Ju LU

Date: 2019.11.12

ASSIGNOR (THIRD INVENTOR):

Signature: _____

Legal Name: Che-Ya CHOU

Date: _____

ASSIGNOR (FOURTH INVENTOR):

Signature: _____

Legal Name: Hsing-Chih LIU

Date: _____

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature: _____

Legal Name: Ying-Chih CHEN

Date: _____

ASSIGNOR (SECOND INVENTOR):

Signature: _____

Legal Name: Yen-Ju LU

Date: _____

ASSIGNOR (THIRD INVENTOR):

Signature: CHE-Ya, Chou

Legal Name: Che-Ya CHOU

Date: 2019/12/16

ASSIGNOR (FOURTH INVENTOR):

Signature: _____

Legal Name: Hsing-Chih LIU

Date: _____

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature: _____

Legal Name: Ying-Chih CHEN

Date: _____

ASSIGNOR (SECOND INVENTOR):

Signature: _____

Legal Name: Yen-Ju LU

Date: _____

ASSIGNOR (THIRD INVENTOR):

Signature: _____

Legal Name: Che-Ya CHOU

Date: _____

ASSIGNOR (FOURTH INVENTOR):

Signature: Hsing-Chih LIU

Legal Name: Hsing-Chih LIU

Date: 2019.11.14